



Material Content Data Sheet				RoHS		Halogen-Free		
Sales Product Name	BGA 616 H6327 MA000808722			Issued		26. September 2017		
MA#								
Package	PG-SOT343-4-2			Weight*		6.93 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	noble metal	gold	7440-57-5	0.003	0.04		405	
	non noble metal	tin	7440-31-5	0.001	0.01		104	
	inorganic material	silicon	7440-21-3	0.021	0.30	0.35	3001	3510
leadframe	inorganic material	silicon	7440-21-3	0.001	0.01		100	
	non noble metal	titanium	7440-32-6	0.003	0.05		498	
	non noble metal	chromium	7440-47-3	0.010	0.15		1493	
	non noble metal	copper	7440-50-8	3.433	49.55	49.76	495528	497619
wire	noble metal	gold	7440-57-5	0.010	0.15	0.15	1482	1482
encapsulation	organic material	carbon black	1333-86-4	0.030	0.44		4374	
	plastics	epoxy resin	-	0.652	9.40		94045	
	inorganic material	silicondioxide	60676-86-0	2.349	33.90	43.74	338998	437417
leadfinish	non noble metal	tin	7440-31-5	0.199	2.88	2.88	28757	28757
plating	noble metal	silver	7440-22-4	0.216	3.12	3.12	31215	31215
*deviation	< 10%			5	Sum in total:	100.00		1000000

Important Remarks:

- 1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
- 2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
- 3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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